

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IPD380P06NM	**Issued**	15. May 2021
MA#	MA005171958		
Package	PG-TO252-3-313	**Weight***	320.02 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.029	1.26	1.26	12588	12588
leadframe	inorganic material	phosphorus	7723-14-0	0.044	0.01		138	
	non noble metal	iron	7439-89-6	0.147	0.05		460	
	non noble metal	copper	7440-50-8	147.096	45.97	46.03	459647	460245
wire	non noble metal	aluminium	7429-90-5	2.993	0.94	0.94	9351	9351
encapsulation	inorganic material	zincoxide	1314-13-2	1.381	0.43		4316	
	miscellaneous	miscellaneous	-	6.906	2.16		21579	
	plastics	epoxy resin	-	20.717	6.47		64737	
	inorganic material	silicondioxide	60676-86-0	109.111	34.09	43.15	340949	431581
leadfinish	non noble metal	tin	7440-31-5	3.740	1.17	1.17	11687	11687
plating	inorganic material	phosphorus	7723-14-0	0.003			11	
	non noble metal	nickel	7440-02-0	1.421	0.44	0.44	4439	4450
solder	non noble metal	tin	7440-31-5	0.065	0.02		202	
	noble metal	silver	7440-22-4	0.081	0.03		252	
	non noble metal	lead	7439-92-1	3.085	0.96	1.01	9640	10094
heatspreader	inorganic material	phosphorus	7723-14-0	0.006			18	
	non noble metal	iron	7439-89-6	0.019	0.01		60	
	non noble metal	copper	7440-50-8	19.177	5.99	6.00	59926	60004
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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